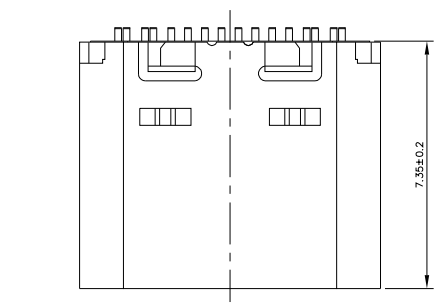
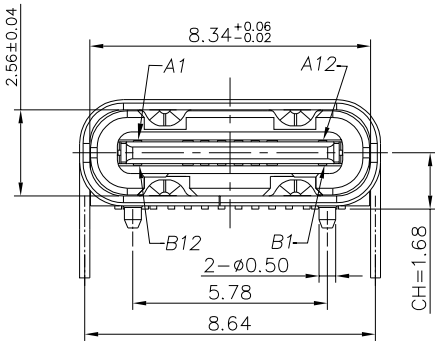
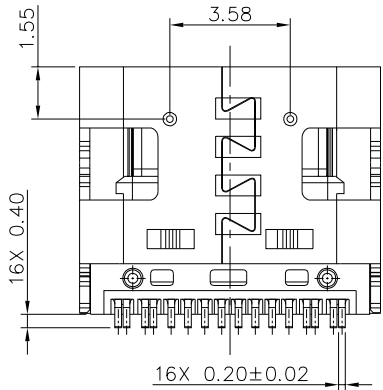
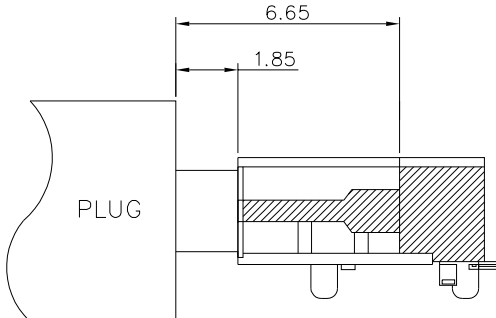
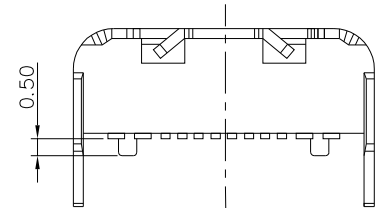
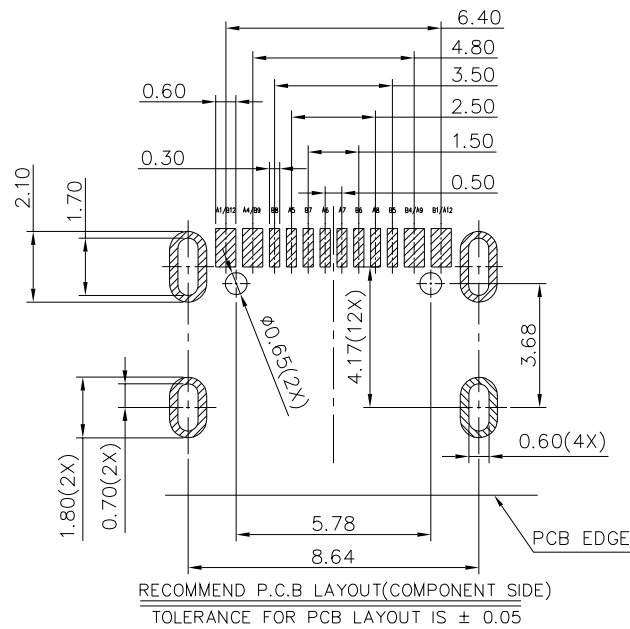


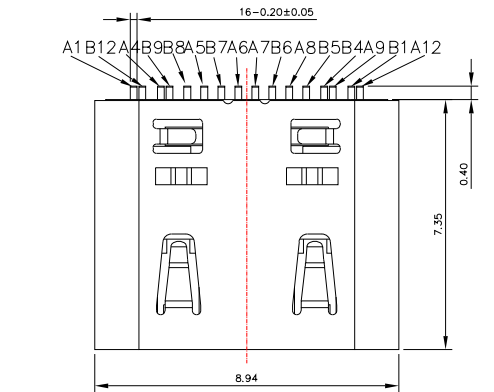
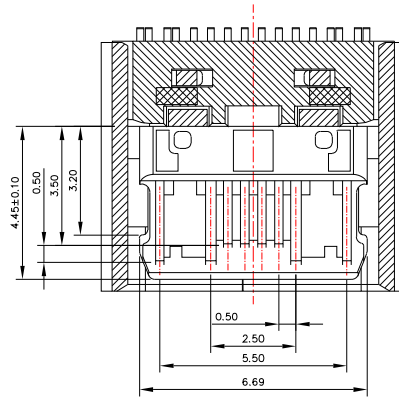
NOTE:
1. Material and Plating: Refer to Appendix 1
2. Electrical Performance:
2.1 Contact impedance: 30MΩ Max FDR INITIAL.
40MΩ Max AFTER TEST.
2.2 Withstand Voltage: 100V AC
2.3 Insulation: 100mΩ Min
2.4 Operating Temperature: -40 ~ 80
3. mechanical properties
3.1 insertion force: 5~20N
3.2 Pull out force: Initial value 8~20N,
tested 6~20N
3.3 lifespan: 10,000 CYCLES

A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

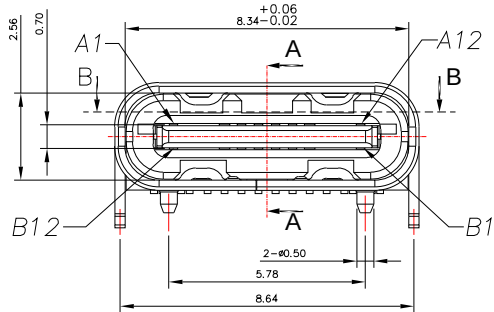
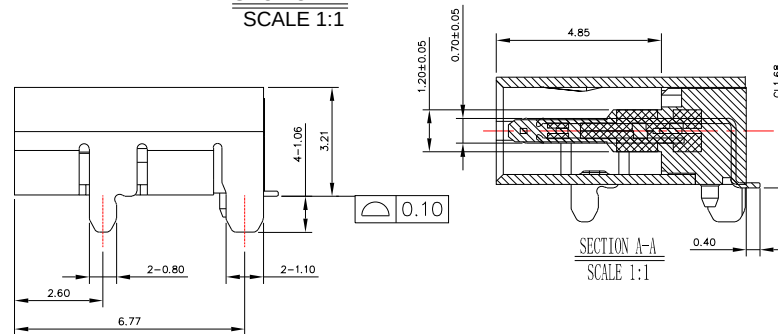
④	Shell	—	1	SUS	—	—
③	Housing	—	1	LCP	Black	—
②	Mid Plate	—	1	SUS	—	—
①	Contacts	—	1 set	C2680-H	Au Plated	—
ITEM	PART NAME	TER'NO.	QTY.	MATERIAL	FINISHING	REMARK

APPROVALS			DATE					
DRAWN								
CHECKED				TITLE:				
APPROVALS				PART NO.		T		
TOLERANCES ARE		30~...	±0.30	ANGLE	UNIT: mm	SCALE: 1:1	PROJ: 	
		10~30	±0.20		±2°	DRAWING NO.	_____	SHEET 1 OF 1
		5~10	±0.15					
		~ 5	±0.10					

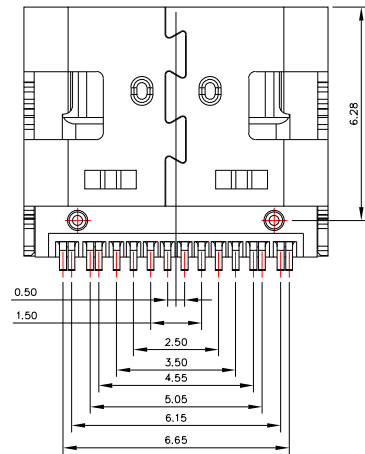
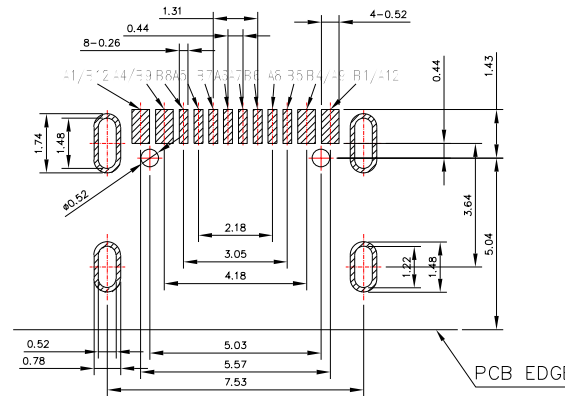
—	A	—	NEW	—	—	—
ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.



SECTION B-B
SCALE 1:1



SECTION A-A
SCALE 1:1



RECOMMEND P.C.B LAYOUT (COMPONENT SIDE)
TOLERANCE FOR PCB LAYOUT IS ± 0.05

NOTE:

1. MATERIAL SPECIFIC/
 1. HOUSING: HIGH TEMPERATURE RESISTANT PLASTIC, UL94 V-0.
 2. CONTACTS: COPPER ALLOY
 3. MID PLATE: STAINLESS STEEL
 4. SHELL: STAINLESS STEEL
2. PLATING SPECIFICATION:
 - 2-1. CONTACTS:
Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
(GOLD PLATING THICKNESS FOLLOW THE P/N)
GOLD FLASH PLATING ON SOLDER AREA
 - 2-2. FRONT SHELL:
Ni 30u" MIN. UNDER PLATED OVER ALL.
3. MECHANICAL PERFORMANCE,
 - 3-1. INSERTION FORCE: 0.5~2.0kgf.
 - 3-2. REMOVAL FORCE: 0.8kgf~2.0kgf.
 - 3-3. DURABILITY: 10000 CYCLES.
4. ELECTRICAL PERFORMANCE,
 - 4-1. CURRENT RATING: 5A
VOLTAGE RATING: 20V
 - 4-2. INSULATION RESISTANCE: 100MΩ MIN
 - 4-3. DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.
 - 4-4. LOW CONTACT RESISTANCE: INITIAL 40mΩ
AFTER 50mΩ
5. ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -30°C~+80°C.
6. IR REFLOW:
THE PEAK TEMPERATURE ON THE BOARD SHALL
BE MAINTAINED FOR 10 SECONDS AT 260°C.

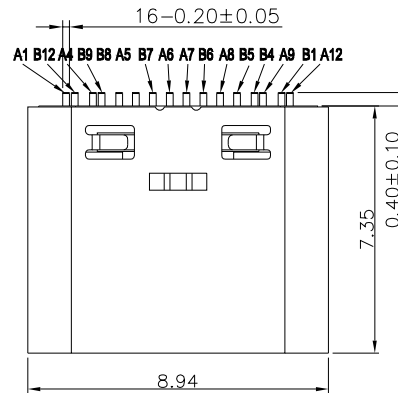
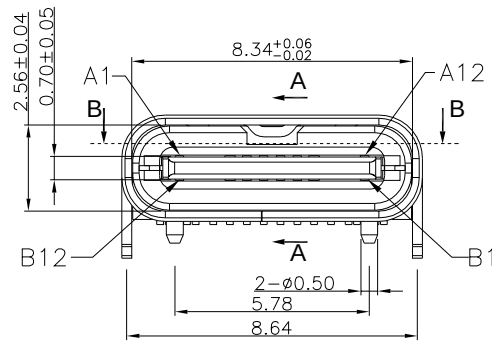
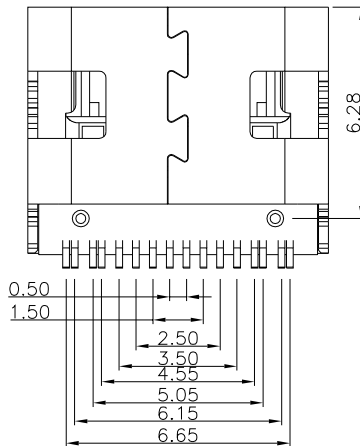
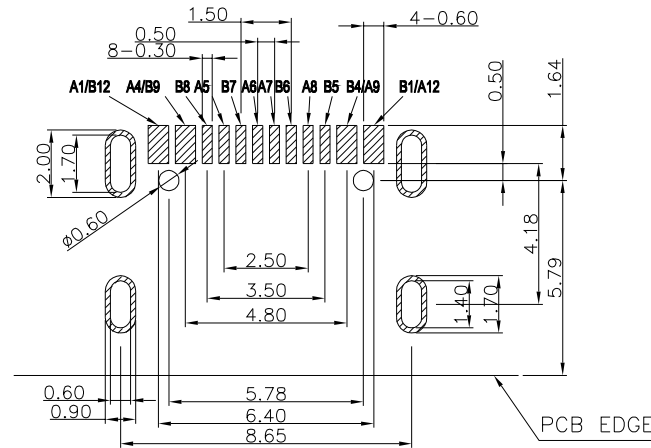
USB TYPE-C PIN ASSIGNMENTS

PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND

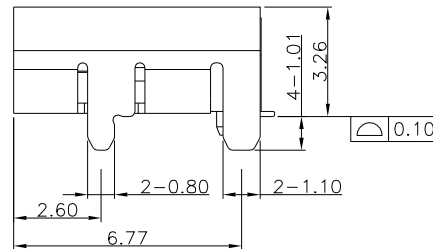
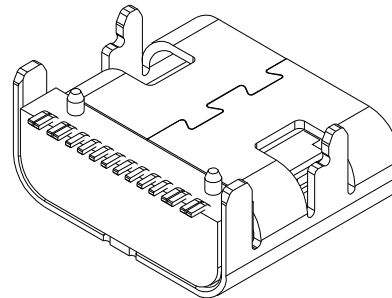
APPROVALS		DATE		TITLE:	
DRAWN					
CHECKED					
APPROVALS				PART NO.	
TOLERANCES ARE		30~ 10~30 5~10 ~5		±0.30 ±0.20 ±0.15 ±0.10	
		ANGLE		UNIT: mm	
		±2°		SCALE: 1:1	
				DRAWING NO.	
				PROJ:	
				SHEET 1 OF 1	

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			

ROHS



RECOMMEND P.C.B LAYOUT(COMPONENT SIDE)
TOLERANCE FOR PCB LAYOUT IS ± 0.05



NOTE:

1. MATERIAL SPECIFICATION:
 1. HOUSING: HIGH TEMPERATURE RESISTANT PLASTIC, UL94 V-0.
 2. CONTACTS: COPPER ALLOY
 3. MID PLATE: STAINLESS STEEL
 4. SHELL: STAINLESS STEEL
2. PLATING SPECIFICATION:
 - 2-1. CONTACTS:

Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
(GOLD PLATING THICKNESS FOLLOW THE P/N)
GOLD FLASH PLATING ON SOLDER AREA
 - 2-2. FRONT SHELL:

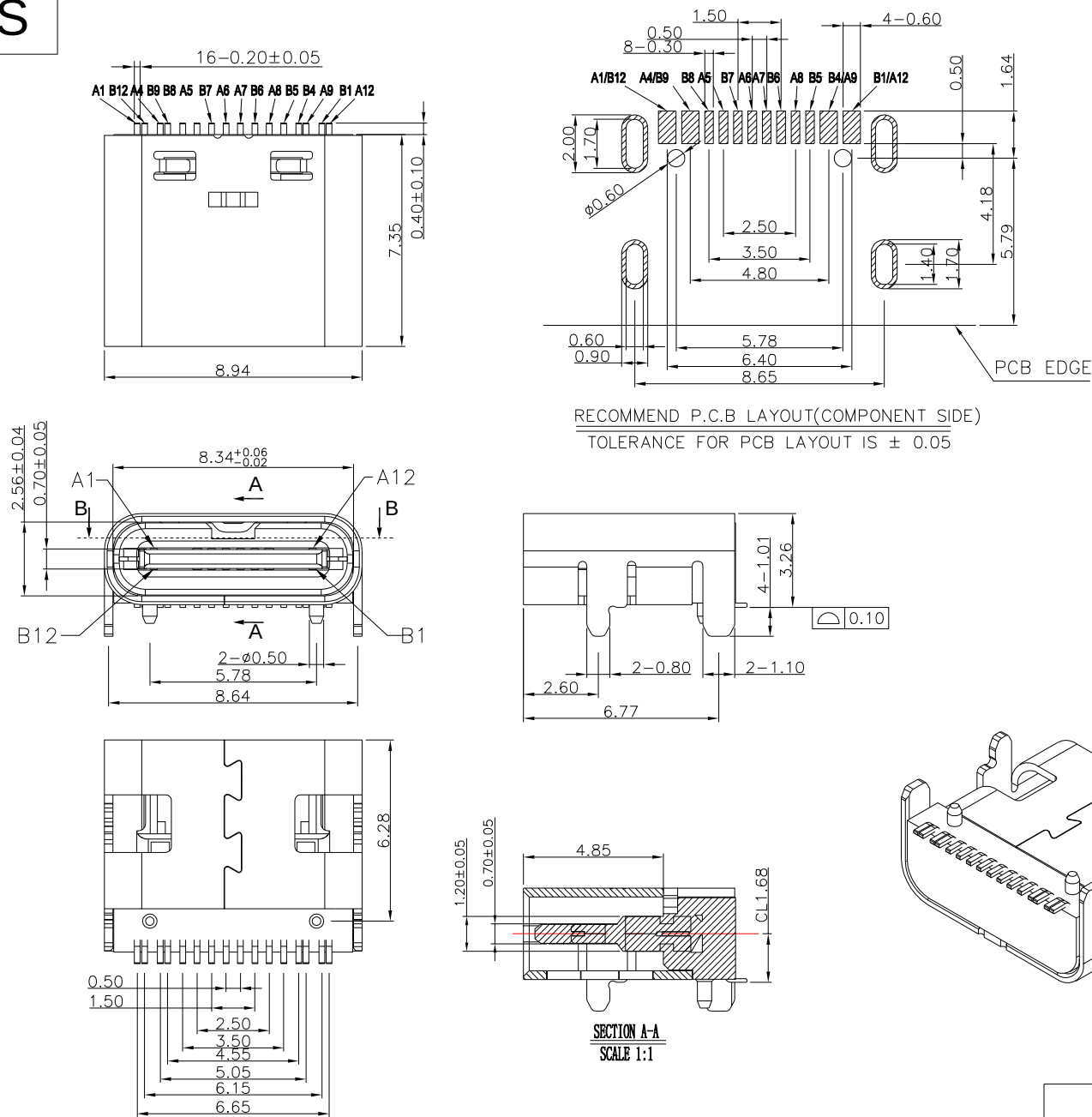
Ni 30u" MIN. UNDER PLATED OVER ALL.
3. MECHANICAL PERFORMANCE,
 - 3-1. INSERTION FORCE: 5~20N.
 - 3-2. REMOVAL FORCE: 8~20N.
 - 3-3. DURABILITY: 10000 CYCLES.
4. ELECTRICAL PERFORMANCE,
 - 4-1. **CURRENT RATING: 6A**
VOLTAGE RATING: 20V
 - 4-2. INSULATION RESISTANCE: 100MΩ MIN
 - 4-3. DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.
5. ENVIRONMENTAL PERFORMANCE:

OPERATING TEMPERATURE: -30°C~+85°C.

A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

APPROVALS				DATE					
DRAWN									
CHECKED				TITLE:					
APPROVALS				PART NO.		T			
D.	TOLERANCES ARE	30~	±0.30	ANGLE	UNIT: mm	SCALE: 1:1	PROJ: 		
		10~30	±0.20						
		5~10	±0.15						
		~ 5	±0.10						
				±2°	DRAWING NO.	_____	SHEET 1 OF 1		

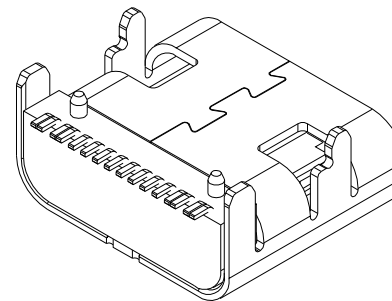
_____	A	_____	NEW	_____	_____	_____
ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.



NOTE:

- MATERIAL SPECIFICATION:
 - HOUSING: HIGH TEMPERATURE RESISTANT PLASTIC, UL94 V-0.
 - CONTACTS: COPPER ALLOY
 - MID PLATE: STAINLESS STEEL
 - SHELL: STAINLESS STEEL
- PLATING SPECIFICATION:
 - CONTACTS:
 - Ni 50u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - (GOLD PLATING THICKNESS FOLLOW THE P/N)
 - GOLD FLASH PLATING ON SOLDER AREA
 - FRONT SHELL:
 - Ni 30u" MIN. UNDER PLATED OVER ALL.
- MECHANICAL PERFORMANCE,
 - INSERTION FORCE: 5~20N.
 - REMOVAL FORCE: 8~20N.
 - DURABILITY: 10000 CYCLES.
- ELECTRICAL PERFORMANCE,
 - CURRENT RATING: 5A
VOLTAGE RATING: 20V
 - INSULATION RESISTANCE: 100M Ω MIN
 - DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.
- ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: $-30^{\circ}\text{C}\sim+85^{\circ}\text{C}$.

A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME



APPROVALS			DATE				
DRAWN							
CHECKED				TITLE:			
APPROVALS				PART NO.		T	
TOLERANCES ARE	30~	±0.30	ANGLE	UNIT: mm	SCALE: 1:1	PROJ: 	
	10~30	±0.20					
	5~10	±0.15					
	~ 5	±0.10					
		±2°	DRAWING NO.		_____	SHEET 1 OF 1	

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			